

AO3402

30V N-Channel MOSFET

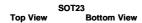
General Description

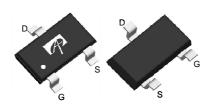
The AO3402 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a load switch or in PWM applications.

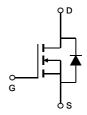
Product Summary

30V $V_{\text{DS}} \\$ I_D (at V_{GS} =10V) 4A $R_{DS(ON)}$ (at V_{GS} =10V) < 52m Ω $R_{DS(ON)}$ (at V_{GS} =4.5V) $<65 \text{m}\Omega$ $R_{DS(ON)}$ (at $V_{GS} = 2.5V$) < 85m Ω









Absolute Maximum Ratings	I _A =25°C unless otherwise noted
Parameter	Symbol

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Parameter		Symbol	Maximum	Units	
Drain-Source Voltage		V_{DS}	30	V	
Gate-Source Voltage		V_{GS}	±12	V	
Continuous Drain	T _A =25℃		4		
Current	T _A =70℃	'D	3.2	A	
Pulsed Drain Current ^C		I _{DM}	15		
	T _A =25℃	В	1.4	W	
Power Dissipation ^B	T _A =70℃	P _D	0.9	VV	
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	C	

Thermal Characteristics					
Parameter		Symbol	Тур	Max	Units
Maximum Junction-to-Ambient A	t ≤ 10s	$R_{\theta JA}$	70	90	€/W
Maximum Junction-to-Ambient AD	Steady-State		100	125	€/W
Maximum Junction-to-Lead	Steady-State	$R_{\theta JL}$	63	80	€/M



Electrical Characteristics (T_J=25℃ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units	
STATIC F	PARAMETERS						
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =250μA, V _{GS} =0V	30			V	
ı	Zero Gate Voltage Drain Current	V_{DS} =30V, V_{GS} =0V			1		
I _{DSS}		T _J =55℃			5	μΑ	
I_{GSS}	Gate-Body leakage current	V _{DS} =0V, V _{GS} =±12V			±100	nA	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS} I_{D}=250\mu A$	0.5	1	1.5	V	
$I_{D(ON)}$	On state drain current	V_{GS} =10V, V_{DS} =5V	15			Α	
	ON) Static Drain-Source On-Resistance	V_{GS} =10V, I_D =4A		43	52	mΩ	
P		T _J =125℃		70	84		
R _{DS(ON)}		V_{GS} =4.5V, I_D =3A		47	65	mΩ	
		V_{GS} =2.5V, I_D =2A		60	85	mΩ	
g _{FS}	Forward Transconductance	V_{DS} =5V, I_D =3.6A		14		S	
V_{SD}	Diode Forward Voltage	I _S =1A,V _{GS} =0V		0.75	1	V	
Is					1.5	Α	
DYNAMIC	PARAMETERS						
C _{iss}	Input Capacitance		185	235	285	pF	
C _{oss}	Output Capacitance	V_{GS} =0V, V_{DS} =15V, f=1MHz	25	35	45	pF	
C _{rss}	Reverse Transfer Capacitance		10	18	25	pF	
R_g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz	2.1	4.3	6.5	Ω	
SWITCHI	NG PARAMETERS	•					
Q _g (10V)	Total Gate Charge			10	12	nC	
Q _g (4.5V)	Total Gate Charge	V _{GS} =10V, V _{DS} =15V, I _D =4A		4.7		nC	
Q_{gs}	Gate Source Charge	V _{GS} =10V, V _{DS} =13V, I _D =4A		0.95		nC	
Q_{gd}	Gate Drain Charge			1.6		nC	
t _{D(on)}	Turn-On DelayTime			3.5		ns	
t _r	Turn-On Rise Time	V_{GS} =10V, V_{DS} =15V, R_L =3.75 Ω ,		1.5		ns	
t _{D(off)}	Turn-Off DelayTime	$R_{GEN}=3\Omega$		17.5		ns	
t _f	Turn-Off Fall Time	7		2.5		ns	
t _{rr}	Body Diode Reverse Recovery Time	I _F =4A, dI/dt=100A/μs		8.5	11	ns	
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =4A, dI/dt=100A/μs		2.6	3.5	nC	

A. The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A =25° C. The value in any given application depends on the user's specific board design.

B. The power dissipation P_D is based on P_D is based on the user's specific board design.

C. Repetitive rating, pulse width limited by junction temperature P_D is based on low frequency and duty cycles to keep

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initial T_J =25 $^{\circ}$ C.

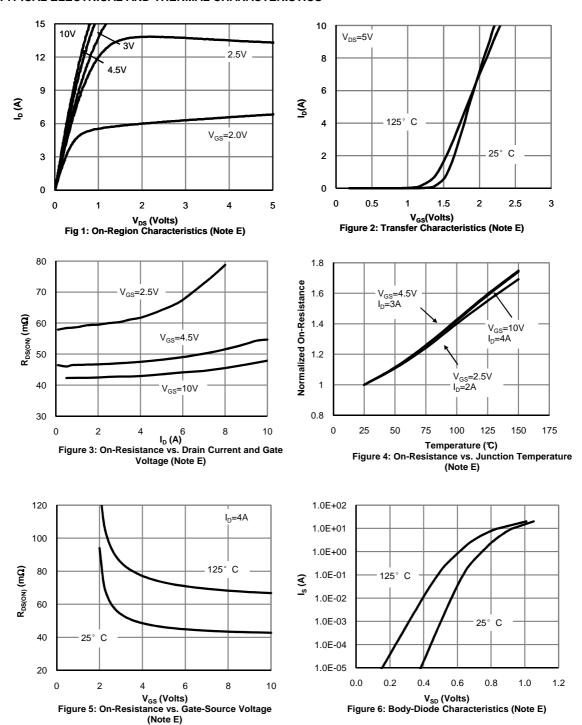
D. The $R_{\theta JA}$ is the sum of the thermal impedence from junction to lead $R_{\theta JL}$ and lead to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using <300µs pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-ambient thermal impedence which is measured with the device mounted on 1in^2 FR-4 board with 2oz. Copper, assuming a maximum junction temperature of $T_{J(MAX)}=150^\circ$ C. The SOA curve provides a single pulse rating.

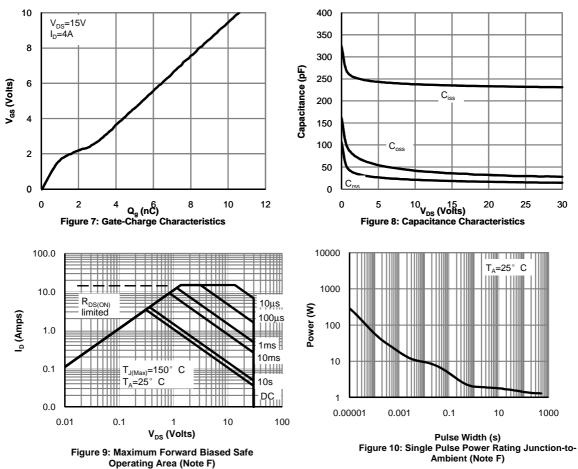


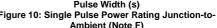
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS





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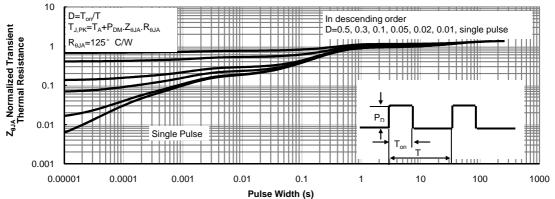
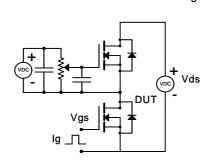
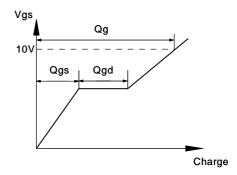


Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)

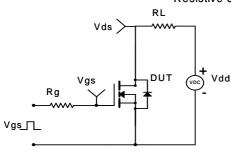


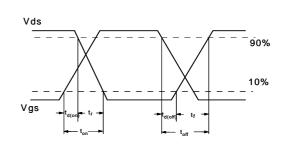
Gate Charge Test Circuit & Waveform





Resistive Switching Test Circuit & Waveforms





Diode Recovery Test Circuit & Waveforms

